

Technical Data Green Products

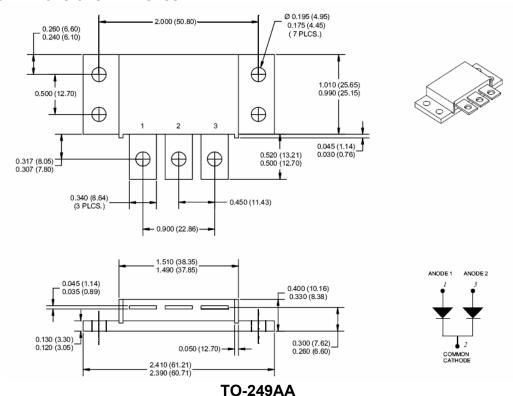
Data Sheet N1239, Rev. -

169CMQ135/169CMQ150 SCHOTTKY RECTIFIER

Applications:

- Switching power supply Converters Free-Wheeling diodes Reverse battery protection Features:
 - 150 °C T_J operation
 - Isolated heatsink
 - Multiple leads per terminal for high frequency, high current PC board mounting
 - · Low profile, high current package
 - Center tap module
 - Low forward voltage drop
 - High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
 - High frequency operation
 - Guard ring for enhanced ruggedness and long term reliability
 - This is a Pb Free Device
 - All SMC parts are traceable to the wafer lot
 - Additional testing can be offered upon request

Mechanical Dimensions: In Inches / mm



MARKING, MOLDING RESIN

Marking for 169CMQ135/150, 1^{st} row SS YYWWL, 2^{nd} row 169CMQ135/150, 3^{rd} row 1 2 3 (Pin) Where YY is the manufacture year

WW is the manufacture week code L is the wafer's Lot Number

Molding resin Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition		Max.	Units
Peak Inverse Voltage	VRWM	-	135	169CMQ135	V
			150	169CMQ150	
Max. Average Forward Current *	I _{F(AV)}	50% duty cycle @T _C = 87°C, rectangular wave form		160	А
Max. Peak One Cycle Non- Repetitive Surge Current (peg leg)	I _{FSM}	8.3 ms, half Sine pulse		960	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 80A, Pulse, T _J = 25 °C	1.05	V
	V_{F2}	@ 80A, Pulse, T _J = 125 °C	0.85	V
Max. Reverse Current (per leg) *	I _{R1}	$@V_R = \text{rated } V_R T_J = 25 ^{\circ}\text{C}$	1.5	mA
	I _{R2}	$@V_R = \text{rated } V_R, T_J = 125 ^{\circ}\text{C}$	21	mA
Max. Junction Capacitance (per leg)	Ст	$@V_R = 5V, T_C = 25 \text{ °C}$ $f_{SIG} = 1MHz$	1300	pF
Typical Series Inductance (per leg)	L _S	Measured lead to lead 5 mm from package body	8.0	nH
Max. Voltage Rate of Change	dv/dt	-	10,000	V/µs

^{*} Pulse Width < 300µs, Duty Cycle <2%

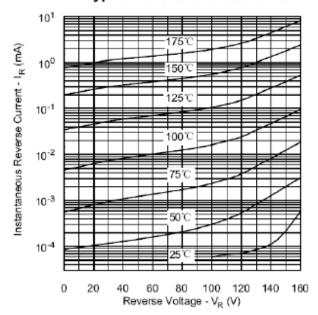
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units	
Max. Junction Temperature	T_J	-	-55 to +150	°C	
Max. Storage Temperature	T _{stg}	-	-55 to +150	°C	
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	1.0	°C/W	
Maximum Thermal Resistance Junction to Case (per package)	$R_{ heta JC}$	DC operation	0.50	°C/W	
Typical Thermal Resistance, case to Heat Sink	$R_{\theta cs}$	Mounting surface, smooth and greased	0.10	°C/W	
Mounting Torque	Тм	-	40(min) 58(max)	Kg-cm	
Approximate Weight	wt	-	58	g	
Case Style	TO-249AA				

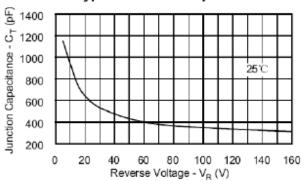
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Typical Forward Characteristics 10^{2} 175℃ 10¹ Instantaneous Forward Current - Ip (A) 125℃ 10⁰ 25°C 10⁻¹ 10⁻² 0.0 0.2 0.4 0.6 8.0 1.0 Forward Voltage Drop - V_F (V)

Typical Reverse Characteristics



Typical Junction Capacitance



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